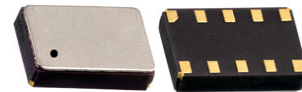


DTCXO Temperature Compensated Real-Time-Clock Module with SPI bus



3.7 x 2.5 x 0.9 mm

AB-RTCMC-32.768kHz-EOA9-S3



RoHS/RoHS II compliant

Moisture Sensitivity Level: MSL=1

FEATURES:

- With state-of-the-art RTC Technology by Micro Crystal AG
- RTC module with built-in “Tuning Fork” crystal oscillating at 32.768 kHz
- Factory calibrated, all built-in Temperature Compensation circuitry Time accuracy Option A & B. See Part Identification on page 7 for details
- Ultra low power consumption: 800nA typ @ VDD = 3.0V / Tamb = 25°C
- Wide clock operating voltage: 1.3 – 5.5V
- Wide interface operating voltage: 1.4 – 5.5V
- Extended operating temperature range: -40°C to +125°C
- SPI serial interface with fast mode SCL clock frequency of 1 MHz
- Provides year, month, day, weekday, hours, minutes and seconds
- Highly versatile alarm and timer functions
- Integrated Low-Voltage Detector, Power-On Reset and Self-Recovery System
- Main Power Supply to Backup Battery switchover circuitry with Trickle Charger
- Programmable CLKOUT pins for peripheral devices (32.768 kHz / 1024 Hz / 32 Hz / 1 Hz)
- Small and compact package size: 3.7 x 2.5 x 0.9 mm. RoHS-compliant and 100% leadfree

APPLICATIONS:

- Wide range in communication & measuring equipment
- Commercial & Industrial applications
- Automotive electronics applications
- Wireless communications
- PDA and Palm Pilots
- Credit Cards with Security Technology

STANDARD SPECIFICATIONS:

Absolute Maximum Ratings

| Parameters | Min. | Typ. | Max. | Units | Notes |
|---|---------|------|----------------------|-------|----------------------------------|
| Supply Voltage (V _{DD}) | GND-0.3 | | +6.0 | V | >GND / <V _{DD} |
| Supply Current (I _{DD} ; I _{SS}) | -50 | | +50 | mA | V _{DD} Pin |
| Input Voltage (V _I) | GND-0.3 | | V _{DD} +0.3 | V | Input Pin |
| Output Voltage (V _O) | GND-0.5 | | V _{DD} +0.5 | V | $\overline{\text{INT}}$ / CLKOUT |
| DC Input Current (I _I) | -10 | | +10 | mA | |
| DC Output Current (I _O) | -10 | | +10 | mA | |
| Total Power Dissipation (P _{TOT}) | | | 300 | mW | |
| Operating Temperature Range (T _{OPR}) | -40 | | +125 | °C | |
| Storage Temperature (T _{STO}) | -55 | | +125 | °C | Stored as bare product |

Frequency and Time Characteristics

V_{DD}=3.0V; V_{SS}=0V; T_{AMB}=+25°C; f_{OSC}=32.768kHz

| Parameters | Min. | Typ. | Max. | Units | Notes |
|---|---|------|------|-------|---|
| 32.768kHz Oscillator Characteristics | | | | | |
| Frequency Accuracy ($\Delta F/F$) | | ±10 | ±20 | ppm | F _{CLKOUT} =32.768kHz; T _{AMB} =+25°C; V _{DD} =3.0V |
| Frequency vs Voltage ($\Delta F/V$) | | ±0.5 | ±1.0 | ppm/V | T _{AMB} =+25°C; V _{DD} =1.4~5.5V |
| Frequency vs Temperature ($\Delta F/T_{OPR}$) | -0.035ppm/°C ² (T _{OPR} -T _O) ² ±10% | | | ppm | T _{OPR} =-40~+125°C; V _{DD} =3.0V |
| Turnover Temperature (T _O) | +20 | +25 | +30 | °C | |
| Aging (first year) | -3 | | +3 | ppm | T _{AMB} =+25°C |
| Start-up Time Voltage (V _{START}) | | | | | |
| Start-up Time (T _{START}) | | 0.5 | 3 | s | T _{AMB} =-40 ~ +85°C |
| | | 1 | 3 | | T _{AMB} =-40 ~ +125°C |
| CLKOUT duty cycle | 40 | 50 | 60 | % | F _{CLKOUT} =32.768kHz; T _{AMB} =+25°C |

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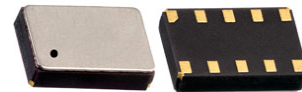
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Revised: 02.05.13

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DTCXO Temperature Compensated Real-Time-Clock Module with SPI bus



3.7 x 2.5 x 0.9 mm

AB-RTCMC-32.768kHz-EOA9-S3



RoHS/RoHS II compliant

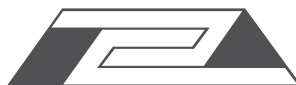
(Continued)

| Parameters | | Min. | Typ. | Max. | Units | Notes |
|---|---|------|----------|----------|-------|-------|
| Time accuracy, DTCXO Digitally Temperature Compensated | | | | | | |
| Time Accuracy Option: A ($\Delta t/t$) | $T_{AMB}=+25^{\circ}\text{C}$ | | ± 1 | ± 3 | ppm | |
| | $T_{AMB}=0 \sim +50^{\circ}\text{C}$ | | ± 2 | ± 4 | | |
| | $T_{AMB}=-10 \sim +65^{\circ}\text{C}$ | | ± 3 | ± 5 | | |
| | $T_{AMB}=-40 \sim +85^{\circ}\text{C}$ | | ± 4 | ± 6 | | |
| | $T_{AMB}=-40 \sim +125^{\circ}\text{C}$ | | ± 5 | ± 8 | | |
| Time Accuracy Option: B ($\Delta t/t$) | $T_{AMB}=+25^{\circ}\text{C}$ | | ± 1 | ± 3 | ppm | |
| | $T_{AMB}=0 \sim +50^{\circ}\text{C}$ | | ± 3 | ± 5 | | |
| | $T_{AMB}=-10 \sim +65^{\circ}\text{C}$ | | ± 5 | ± 10 | | |
| | $T_{AMB}=-40 \sim +85^{\circ}\text{C}$ | | ± 10 | ± 25 | | |
| | $T_{AMB}=-40 \sim +125^{\circ}\text{C}$ | | ± 15 | ± 30 | | |

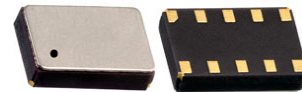
Static Characteristics

$V_{DD}=1.4\sim 5.5\text{V}$; $V_{SS}=0\text{V}$; $T_{AMB}=-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$; $f_{OSC}=32.768\text{kHz}$

| Parameters | | Min. | Typ. | Max. | Units | Notes |
|--|---|------|------|------|---------------|---|
| Supplies | | | | | | |
| Supply Voltage (V_{DD}) | | 1.4 | | 5.5 | V | Time-keeping mode $I^2\text{C}$ bus reduced speed |
| | | 2.1 | | 5.5 | | $I^2\text{C}$ bus full speed |
| Minimum Supply Voltage Detection (V_{LOW1}) | | 1.8 | | 2.1 | V | $T_{AMB}=-40 \sim +125^{\circ}\text{C}$ |
| Minimum Supply Voltage Detection (V_{LOW2}) | | 1.0 | | 1.4 | V | $T_{AMB}=-40 \sim +125^{\circ}\text{C}$ |
| Main Supply to Backup Supply Switchover Hysteresis (V_{HYST}) | | | 20 | | mV | V_{DD} to $V_{BACK} = 3.0\text{V}$ |
| Supply Current I_{DD} ($V_{BACK}=0\text{V}$) or I_{BACK} ($V_{DD}=0\text{V}$) | $V_{DD}=1.4\text{V}$ $T_{AMB}=-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$ | | 0.6 | 1.5 | μA | SPI bus inactive CLKOUT disabled $V_{BACK}= 0\text{V}$ Or $V_{DD}= 0\text{V}$ |
| | $V_{DD}=1.4\text{V}$ $T_{AMB}=-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ | | | 4.6 | | |
| | $V_{DD}=3.3\text{V}$ $T_{AMB}=-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$ | | 0.8 | 2.0 | | |
| | $V_{DD}=3.3\text{V}$ $T_{AMB}=-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ | | | 5.2 | | |
| | $V_{DD}=5.0\text{V}$ $T_{AMB}=-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$ | | 0.9 | 2.2 | | |
| | $V_{DD}=5.0\text{V}$ $T_{AMB}=-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ | | | 5.5 | | |
| | | | | | | |



DTCXO Temperature Compensated Real-Time-Clock Module with SPI bus



3.7 x 2.5 x 0.9 mm

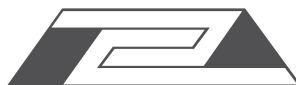
AB-RTCMC-32.768kHz-EOA9-S3



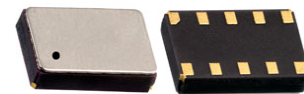
RoHS/RoHS II compliant

(Continued)

| Parameters | | Min. | Typ. | Max. | Units | Notes |
|--|--|---------------|------|---------------|---------|--|
| Supply Current (I_{DD}) | SCL= 200kHz V_{DD} = 1.4V T_{AMB} = -40°C ~ +85°C | | | 14 | μ A | SPI bus active CLKOUT disabled |
| | SCL= 200kHz V_{DD} = 1.4V T_{AMB} = -40°C ~ +125°C | | | 18 | | |
| | SCL= 1MHz V_{DD} = 3.3V T_{AMB} = -40°C ~ +85°C | | | 50 | | |
| | SCL= 1MHz V_{DD} = 3.3V T_{AMB} = -40°C ~ +125°C | | | 55 | | |
| | SCL= 1MHz V_{DD} = 5.0V T_{AMB} = -40°C ~ +85°C | | | 65 | | |
| | SCL= 1MHz V_{DD} = 5.0V T_{AMB} = -40°C ~ +125°C | | | 75 | | |
| Current Consumption (I_{DD32K}) | V_{DD} =5.0V | | 2.5 | 3.4 | μ A | SPI bus inactive CLKOUT =32.768kHz C_{LOAD} =7.5pF |
| | V_{DD} =3.3V | | 1.5 | 2.2 | | |
| | V_{DD} =1.4V | | 1.1 | 1.6 | | |
| Input | | | | | | |
| LOW Level Input Voltage (V_{IL}) | | | | 20%* V_{DD} | V | V_{DD} = 1.4 ~ 5.5 V_{DD} Pins:SCL,SDI,CLKOE,CE |
| HIGH Level Input Voltage (V_{IH}) | | 80%* V_{DD} | | | V | |
| Input Leakage Current (I_L) | T_{amb} =-40 ~+85°C | -1 | | +1 | μ A | $V_{SS}>V_I<V_{DD}$ |
| | T_{amb} =-40 ~+125°C | -1.5 | | +1.5 | | |
| Input Capacitance (C_I) | | | | 7 | pF | |



DTCXO Temperature Compensated Real-Time-Clock Module with SPI bus



3.7 x 2.5 x 0.9 mm

AB-RTCMC-32.768kHz-EOA9-S3



RoHS/RoHS II compliant

(Continued)

| Parameters | | Min. | Typ. | Max. | Units | Notes |
|---|---|------|------|------|-------------|-------|
| Output | | | | | | |
| HIGH Level Output Voltage (V_{OH}) | $V_{DD} = 1.4V$; $I_{OH} = 0.1mA$ | 1.0 | | | V | |
| | $V_{DD} = 3.3V$; $I_{OH} = 1.5mA$ | 2.7 | | | | |
| | $V_{DD} = 5.0V$; $I_{OH} = 2.0mA$ | 4.5 | | | | |
| LOW Level Output Voltage (V_{OL}) | $V_{DD} = 1.4V$; $I_{OL} = 0.4mA$ | | | 0.2 | V | |
| | $V_{DD} = 3.3V$; $I_{OL} = 1.5mA$ | | | 0.25 | | |
| | $V_{DD} = 5.0V$; $I_{OL} = 5.0mA$ | | | 0.8 | | |
| HIGH Level Output Current (I_{OH}) | $V_{OH} = 4.5V$ / $V_{DD} = 5V$ | | | 2.0 | mA | |
| LOW Level Output Current (I_{OL}) | $V_{OL} = 0.8V$ / $V_{DD} = 5V$ | | | -5.0 | mA | |
| Output Leakage Current (I_{LO}) | $V_O = V_{DD}$ OR V_{SS} $T_{AMB} = -40^{\circ}C \sim +85^{\circ}C$ | -1 | 0 | +1 | μA | |
| | $V_O = V_{DD}$ OR V_{SS} $T_{AMB} = -40^{\circ}C \sim +125^{\circ}C$ | -1.5 | 0 | +1.5 | | |
| Operating Temperature Range | | | | | | |
| Operating Temperature Range (T_{OPR}) | | -40 | | +125 | $^{\circ}C$ | |
| EEPROM Characteristics | | | | | | |
| Read Voltage (V_{Read}) | $T_{AMB} = -40^{\circ}C \sim +125^{\circ}C$ | 1.4 | | | V | |
| Programming Voltage (V_{Prog}) | $T_{AMB} = -40^{\circ}C \sim +125^{\circ}C$ | 2.2 | | | V | |
| EEPROM Programming Time (T_{Prog}) | $T_{AMB} = -40^{\circ}C \sim +125^{\circ}C$ 1 Byte EEPROM User | | | 35 | ms | |
| | $T_{AMB} = -40^{\circ}C \sim +125^{\circ}C$ 1 Byte EEPROM Control | | | 100 | | |
| | $T_{AMB} = -40^{\circ}C \sim +125^{\circ}C$ 2-4 Byte EEPROM Control | | | 135 | | |
| EEPROM Write/Erase Cycles (V_{HYST}) | V_{DD} to $V_{BACK} = 3.0V$ | 5000 | | | Cycles | |

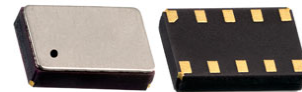


DTCXO Temperature Compensated Real-Time-Clock Module with SPI bus

AB-RTCMC-32.768kHz-EOA9-S3



RoHS/RoHS II compliant



3.7 x 2.5 x 0.9 mm

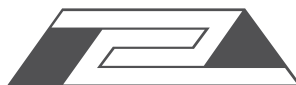
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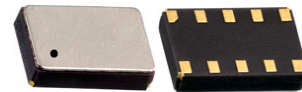
| Parameters | | Min. | Typ. | Max. | Units | Notes |
|---|-----------------------------------|------|------|------|-------|---|
| Trickle Charger | | | | | | |
| Current Limiting Resistors | R80K | | 80 | | kΩ | V _{DD} = 5.0V V _{BACK} = 3.0V T _{AMB} = 25°C |
| | R20k | | 20 | | | |
| | R5k | | 5 | | | |
| | R1.5k | | 1.5 | | | |
| Thermometer | | | | | | |
| Thermometer Precision (T _E) | T _{AMB} = -40°C ~ +85°C | | ±4 | | °C | |
| | T _{AMB} = -40°C ~ +125°C | | ±6 | | | |

SPI Interface Dynamic Characteristics

V_{SS}=0V; T_{AMB}=-40°C ~+125°C; All timing values are valid within the operating supply voltage range and references to V_{IL} and V_{IH} with an input voltage swing from V_{SS} and V_{DD}.

| Parameters | Symbol | Notes | V _{DD} =1.6V | | V _{DD} =2.4V | | V _{DD} =3.3V | | V _{DD} =5.0V | | Units |
|----------------------------|-------------------------|---|-----------------------|------|-----------------------|------|-----------------------|------|-----------------------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| SCL Clock Frequency | f _{clk(SCL)} | | | 0.2 | | 0.6 | | 1.0 | | 1.0 | MHz |
| SCL Time | t _{SCL} | | 5 | | 1.7 | | 1 | | 1 | | μs |
| Clock HIGH Time | t _{clk(H)} | | 1500 | | 700 | | 400 | | 400 | | ns |
| Clock LOW Time | t _{clk(L)} | | 1500 | | 700 | | 400 | | 400 | | ns |
| Rise Time | t _r | For SCL signal | | 800 | | 800 | | 200 | | 200 | ns |
| Fall Time | t _f | For SCL signal | | 800 | | 800 | | 200 | | 200 | ns |
| CE Setup Time | t _{su(CE)} | | 100 | | 100 | | 100 | | 100 | | ns |
| CE Hold Time | t _{h(CE)} | | 500 | | 300 | | 200 | | 200 | | ns |
| CE Recovery Time | t _{rec(CE)} | | 400 | | 300 | | 200 | | 200 | | ns |
| CE Pulse Width | t _{w(CE)} | Measured after valid subaddress is received | | 0.49 | | 0.49 | | 0.49 | | 0.49 | s |
| Setup Time | t _{su} | Setup time for SDI data | 20 | | 20 | | 20 | | 20 | | ns |
| Hold Time | t _h | Hold time for SDI data | 500 | | 300 | | 200 | | 200 | | ns |
| SDO Read Delay Time | t _{d(R)SDO} | Bus load = 50pF | | 1300 | | 650 | | 350 | | 350 | ns |
| SDO Disable Time | t _{dis(SDO)} | No load value; bus will be held up by bus-capacitance; use RC time constant with application values | | 200 | | 100 | | 50 | | 50 | ns |
| Transition Time SDI to SDO | t _{t(SDI-SDO)} | Prepare for 0s to avoid bus conflict | 0 | | 0 | | 0 | | 0 | | ns |





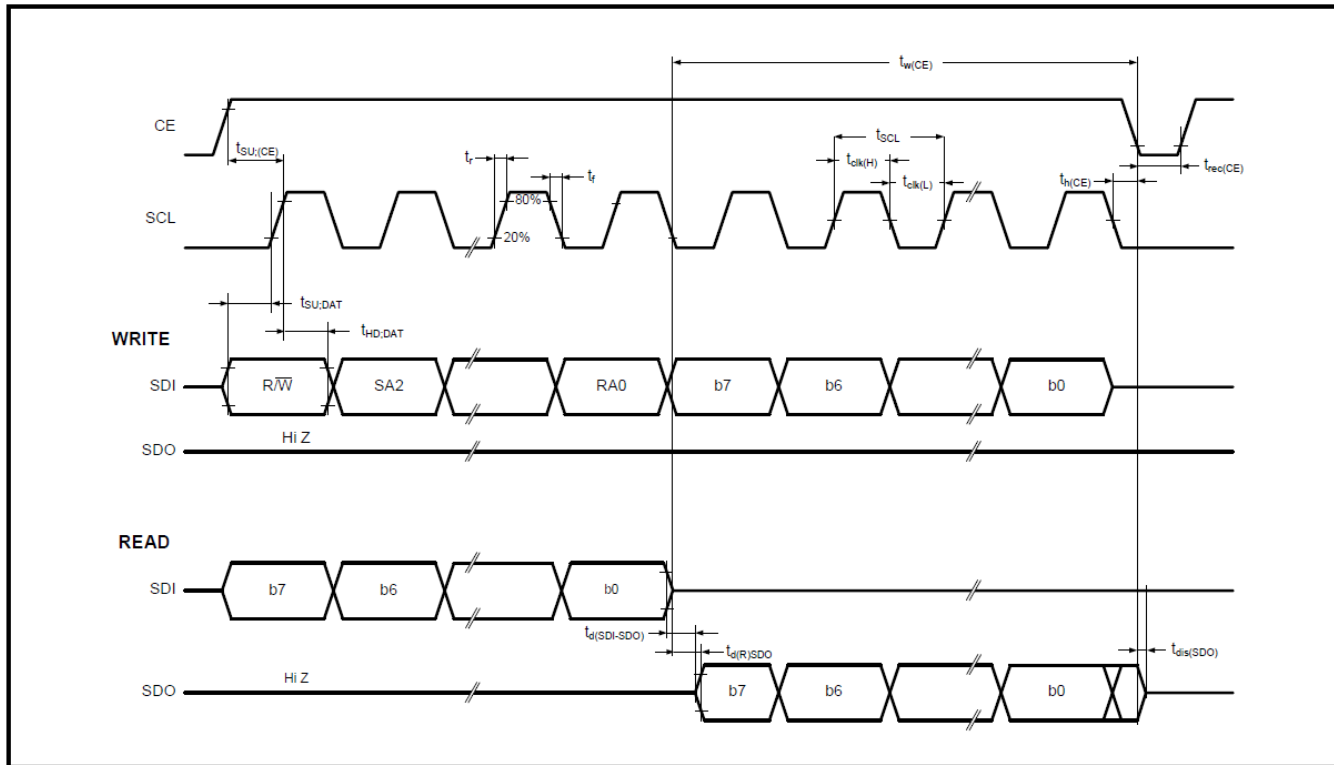
3.7 x 2.5 x 0.9 mm

AB-RTCMC-32.768kHz-EOA9-S3



RoHS/RoHS II compliant

Interface Timing Characteristics



PART IDENTIFICATION:

AB-RTCMC-32.768 kHz-EOA9-S3---

| Operating Temp. Range |
|-----------------------|
| D: -40 ~ +85°C |
| H: -40 ~ +125°C |

| Timing Accuracy |
|----------------------|
| A: see Table 1 below |
| B: see Table 1 below |

| Packaging |
|-----------------|
| Blank: Bulk |
| T: 1000pcs/reel |

Table 1. Time accuracy, DTCXO Digitally Temperature Compensated

| Parameters | | Min. | Typ. | Max. | Units |
|-------------------------|---|------|----------|----------|-------|
| Time Accuracy Option: A | $T_{AMB}=+25^{\circ}\text{C}$ | | ± 1 | ± 3 | ppm |
| | $T_{AMB}=0 \sim +50^{\circ}\text{C}$ | | ± 2 | ± 4 | |
| | $T_{AMB}=-10 \sim +65^{\circ}\text{C}$ | | ± 3 | ± 5 | |
| | $T_{AMB}=-40 \sim +85^{\circ}\text{C}$ | | ± 4 | ± 6 | |
| | $T_{AMB}=-40 \sim +125^{\circ}\text{C}$ | | ± 5 | ± 8 | |
| Time Accuracy Option: B | $T_{AMB}=+25^{\circ}\text{C}$ | | ± 1 | ± 3 | ppm |
| | $T_{AMB}=0 \sim +50^{\circ}\text{C}$ | | ± 3 | ± 5 | |
| | $T_{AMB}=-10 \sim +65^{\circ}\text{C}$ | | ± 5 | ± 10 | |
| | $T_{AMB}=-40 \sim +85^{\circ}\text{C}$ | | ± 10 | ± 25 | |
| | $T_{AMB}=-40 \sim +125^{\circ}\text{C}$ | | ± 15 | ± 30 | |

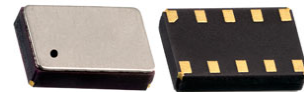


DTCXO Temperature Compensated Real-Time-Clock Module with SPI bus

AB-RTCMC-32.768kHz-EOA9-S3

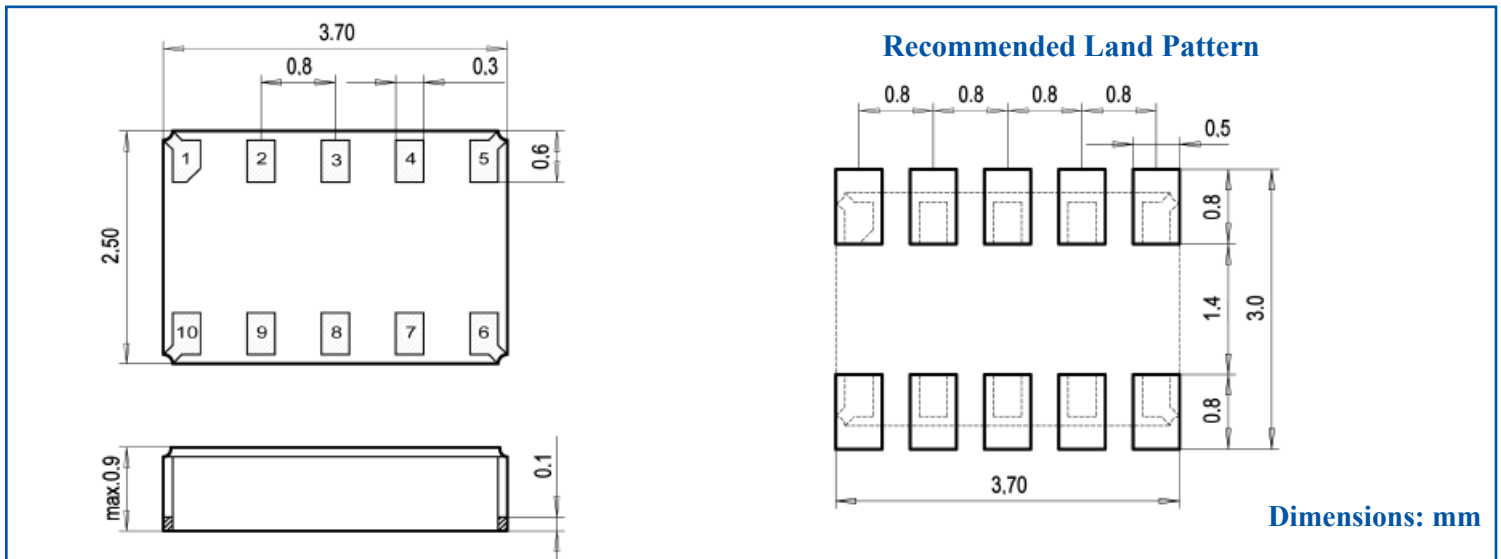


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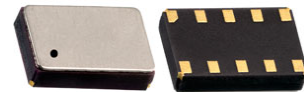
OUTLINE DIMENSIONS:



PIN DESCRIPTION:

| Pin No. | Pin Name | Function |
|---------|-------------------------|---|
| 1 | CLKOE | CLKOUT enable/disable pin; enable is active HIGH; tie to GND when not using CLKOUT |
| 2 | V _{DD} | Positive supply voltage; positive or negative steps in supply voltage may affect oscillator performance, recommend 10 nF decoupling capacitor close to device |
| 3 | CLKOUT | Clock Output pin; CLKOUT or $\overline{\text{INT}}$ function can be selected.(Control_1; bit7; Clk/Int) CLKOUT output push-pull / $\overline{\text{INT}}$ function open-drain requiring pull-up resistor |
| 4 | SCL | Serial Clock Input pin; may float when CE inactive |
| 5 | SDO | Serial Data Output pin; push-pull; high-impedance when not driving; can be connected to SDI for single-wire data line. |
| 6 | V _{SS} | Ground |
| 7 | $\overline{\text{INT}}$ | Interrupt output pin; open-drain; active LOW |
| 8 | CE | Chip Enable input; active HIGH |
| 9 | V _{BACKUP} | Backup Supply Voltage; tie to GND when not using backup supply voltage |
| 10 | SDI | Serial Data Input pin; may float when CE inactive |

DTCXO Temperature Compensated Real-Time-Clock Module with SPI bus



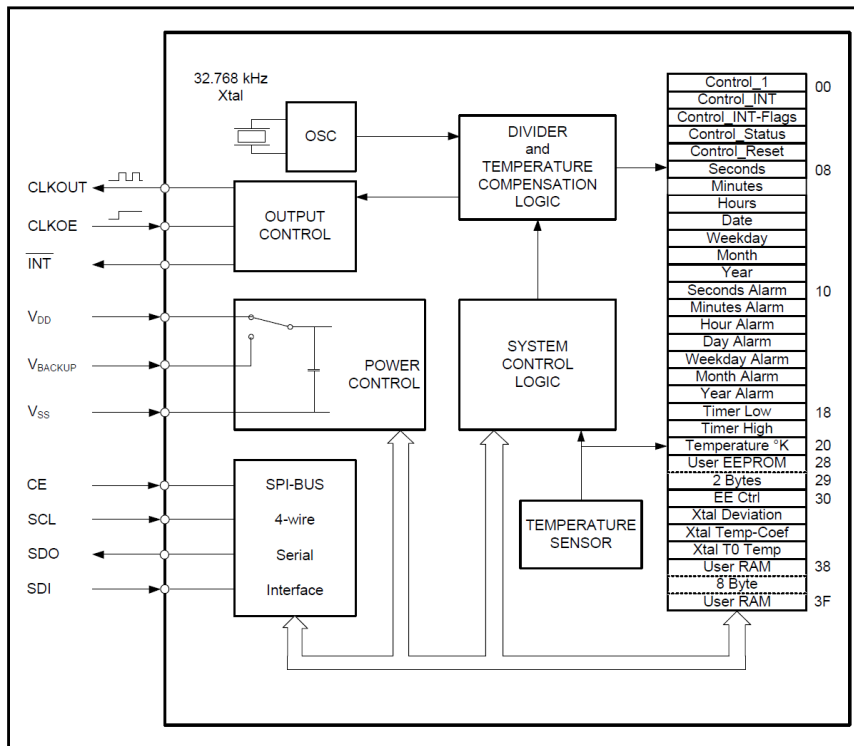
AB-RTCMC-32.768kHz-EOA9-S3



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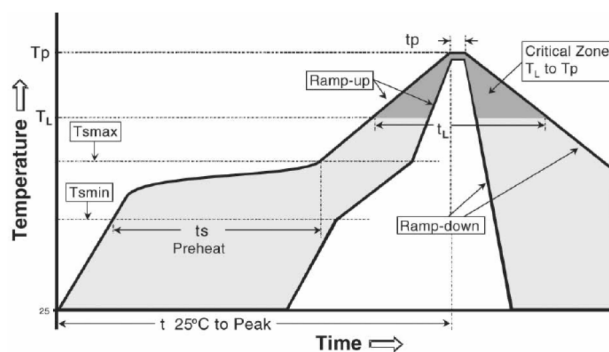
3.7 x 2.5 x 0.9 mm

BLOCK DIAGRAM:



RECOMMENDED REFLOW PROFILE:

Maximum Reflow Conditions in accordance with IPC/JEDEC J-STD-020C “Pb-free”



| Temperature | Conditions | Units |
|---|----------------|-------|
| Average Ramp-up Rate (T _{Smin} to T _P) | 3°C/second max | °C/s |
| Ramp Down Rate (T _{cool}) | 6°C/second max | °C/s |
| Time 25°C to Peak Temperature (T _{to-peak}) | 8 minutes max | m |
| Preheat | | |
| Temperature Min (T _{Smin}) | 150 | °C |
| Temperature Max (T _{Smax}) | 200 | °C |
| Time T _{Smin} to T _{Smax} (ts) | 60 ~ 180 | sec |
| Time Above Liquidus | | |
| Temperature Liquidus (T _L) | 217 | °C |
| Time above Liquidus (t _L) | 60 ~ 150 | sec |
| Peak Temperature | | |
| Peak Temperature (T _P) | 260 | °C |
| Time within 5°C of Peak Temperature (t _p) | 20 ~ 40 | sec |

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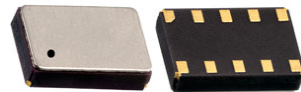
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DTCXO Temperature Compensated Real-Time-Clock Module with SPI bus

AB-RTCMC-32.768kHz-EOA9-S3



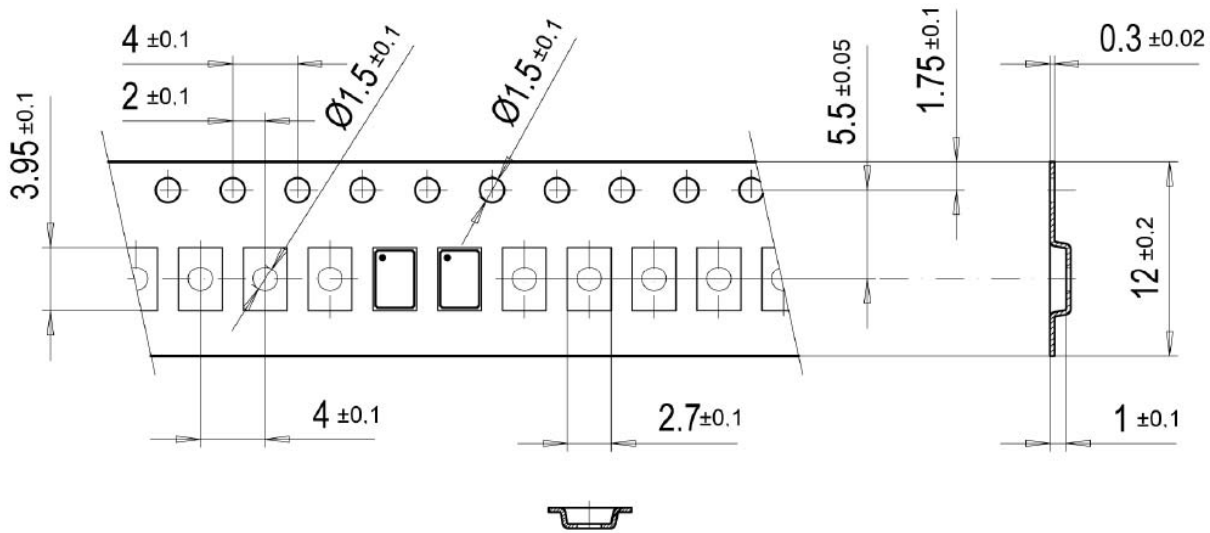
RoHS/RoHS II compliant



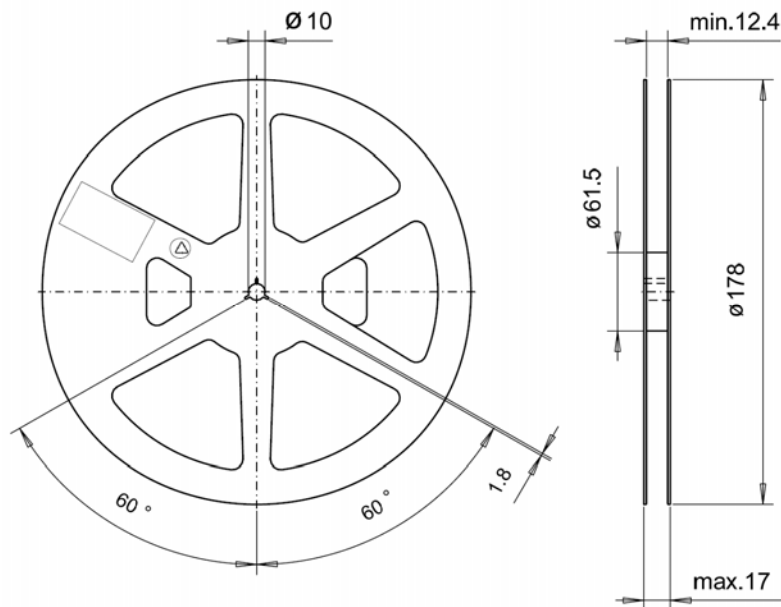
3.7 x 2.5 x 0.9 mm

TAPE & REEL:

T = 1000pcs/reel



User Direction of Feed



Dimension: mm

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30332 Esperanza, Rancho Santa Margarita, California 92688
tel 949-546-8000 | fax 949-546-8001 | www.abracon.com

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: org@lifeelectronics.ru